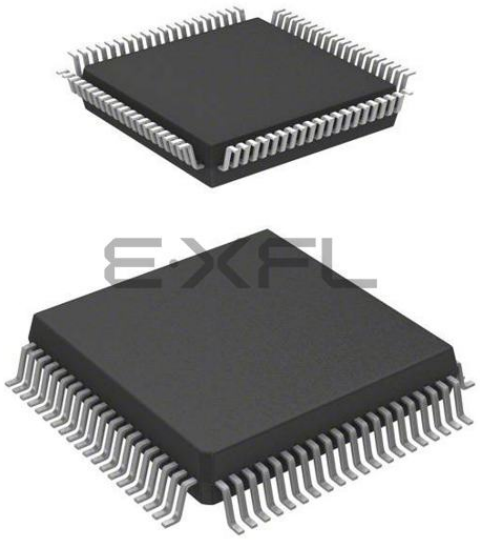

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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	H8S/2600
Core Size	16-Bit
Speed	20MHz
Connectivity	CANbus, SCI
Peripherals	POR, PWM, WDT
Number of I/O	43
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-20°C ~ 75°C (TA)
Mounting Type	Surface Mount
Package / Case	80-BQFP
Supplier Device Package	80-QFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/df2612fa20v

— 16 × 16-bit register-register multiply: 4 states
— 32 ÷ 16-bit register-register divide: 20 states

- Two CPU operating modes
  — Normal mode*
  — Advanced mode
- Power-down state
  — Transition to power-down state by SLEEP instruction
  — CPU clock speed selection

Note: * Normal mode is not available in this LSI.

2.1.1 Differences between H8S/2600 CPU and H8S/2000 CPU

The differences between the H8S/2600 CPU and the H8S/2000 CPU are shown below.

- Register configuration
  The MAC register is supported by the H8S/2600 CPU only.
- Basic instructions
  The four instructions MAC, CLRMAC, LDMAC, and STMAC are supported by the H8S/2600 CPU only.
- The number of execution states of the MULXU and MULXS instructions;

		Execution States	
Instruction	**Mnemonic**	**H8S/2600**	**H8S/2000**
MULXU	MULXU.B Rs, Rd	3	12
	MULXU.W Rs, ERd	4	20
MULXS	MULXS.B Rs, Rd	4	13
	MULXS.W Rs, ERd	5	21

In addition, there are differences in address space, CCR and EXR register functions, and power-down modes, etc., depending on the model.

5.3.4 IRQ Status Register (ISR)

ISR is an 8-bit readable/writable register that indicates the status of IRQ0 to IRQ5 interrupt requests.

Bit	Bit Name	Initial Value	R/W	Description
7, 6	—	All 0	R/W	Reserved Only 0 should be written to these bits.
5	IRQ5F	0	R/W	[Setting condition] • When the interrupt source selected by the ISCR registers occurs [Clearing conditions] • Cleared by reading IRQnF flag when IRQnF = 1, then writing 0 to IRQnF flag • When interrupt exception handling is executed when low-level detection is set and $\overline{\text{IRQn}}$ input is high • When IRQn interrupt exception handling is executed when falling, rising, or both-edge detection is set • When the DTC is activated by an IRQn interrupt, and the DISEL bit in MRB of the DTC is cleared to 0 (n = 5 to 0)
4	IRQ4F	0	R/W	
3	IRQ3F	0	R/W	
2	IRQ2F	0	R/W	
1	IRQ1F	0	R/W	
0	IRQ0F	0	R/W	

7. The CPU generates a vector address for the accepted interrupt and starts execution of the interrupt handling routine at the address indicated by the contents of the vector address in the vector table.

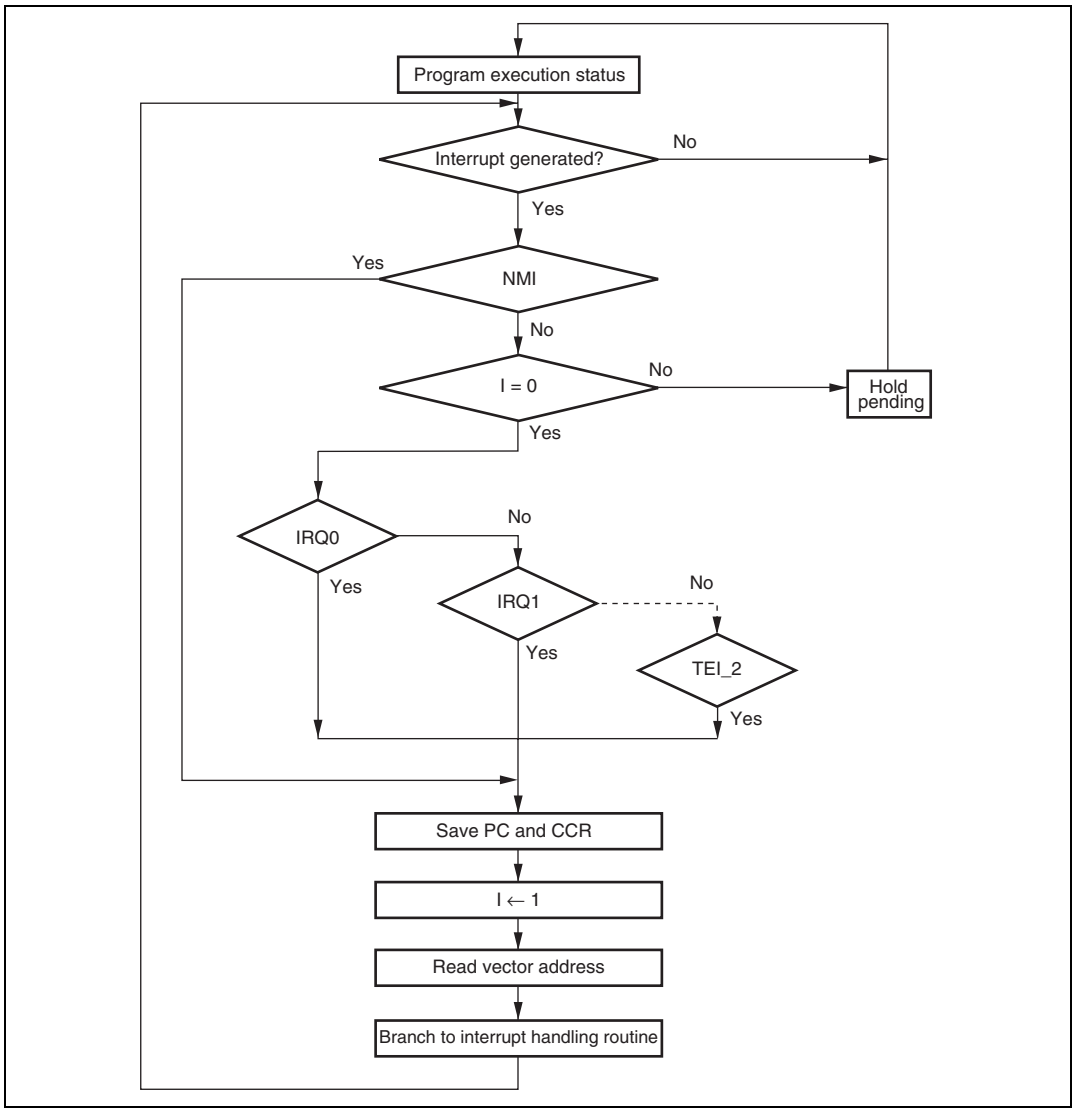


Figure 5.3 Flowchart of Procedure Up to Interrupt Acceptance in Interrupt Control Mode 0

Table 5.5 Number of States in Interrupt Handling Routine Execution Status

		Object of Access				
			External Device*			
			8 Bit Bus		16 Bit Bus	
Symbol		Internal Memory	2-State Access	3-State Access	2-State Access	3-State Access
Instruction fetch	S_I	1	4	6 + 2m	2	3 + m
Branch address read	S_J					
Stack manipulation	S_K					

Legend:
M: Number of wait states in an external device access.
Note: * Cannot be used in this LSI.

5.6.5 DTC Activation by Interrupt

The DTC can be activated by an interrupt. For details, see section 8, Data Transfer Controller (DTC).

Note: No DTC is implemented in the H8S/2614 and H8S/2616.

5.7 Usage Notes

5.7.1 Contention between Interrupt Generation and Disabling

When an interrupt enable bit is cleared to 0 to disable interrupts, the disabling becomes effective after execution of the instruction.

When an interrupt enable bit is cleared to 0 by an instruction such as BCLR or MOV, and if an interrupt is generated during execution of the instruction, the interrupt concerned will still be enabled on completion of the instruction, and so interrupt exception handling for that interrupt will be executed on completion of the instruction. However, if there is an interrupt request of higher priority than that interrupt, interrupt exception handling will be executed for the higher-priority interrupt, and the lower-priority interrupt will be ignored.

The same also applies when an interrupt source flag is cleared to 0.

Figure 5.6 shows an example in which the TGIEA bit in the TPU's TIER_0 register is cleared to 0.

The above contention will not occur if an enable bit or interrupt source flag is cleared to 0 while the interrupt is masked.

8.2 Register Configuration

The DTC has the following registers.

- DTC mode register A (MRA)
- DTC mode register B (MRB)
- DTC source address register (SAR)
- DTC destination address register (DAR)
- DTC transfer count register A (CRA)
- DTC transfer count register B (CRB)

These six registers cannot be directly accessed from the CPU.

When activated, the DTC reads a set of register information that is stored in on-chip RAM to the corresponding DTC registers and transfers data. After the data transfer, it writes a set of updated register information back to the RAM.

- DTC enable registers (DTCER)
- DTC vector register (DTVECR)

For details on register addresses and register states during each process, refer to appendix A, On-Chip I/O Register.

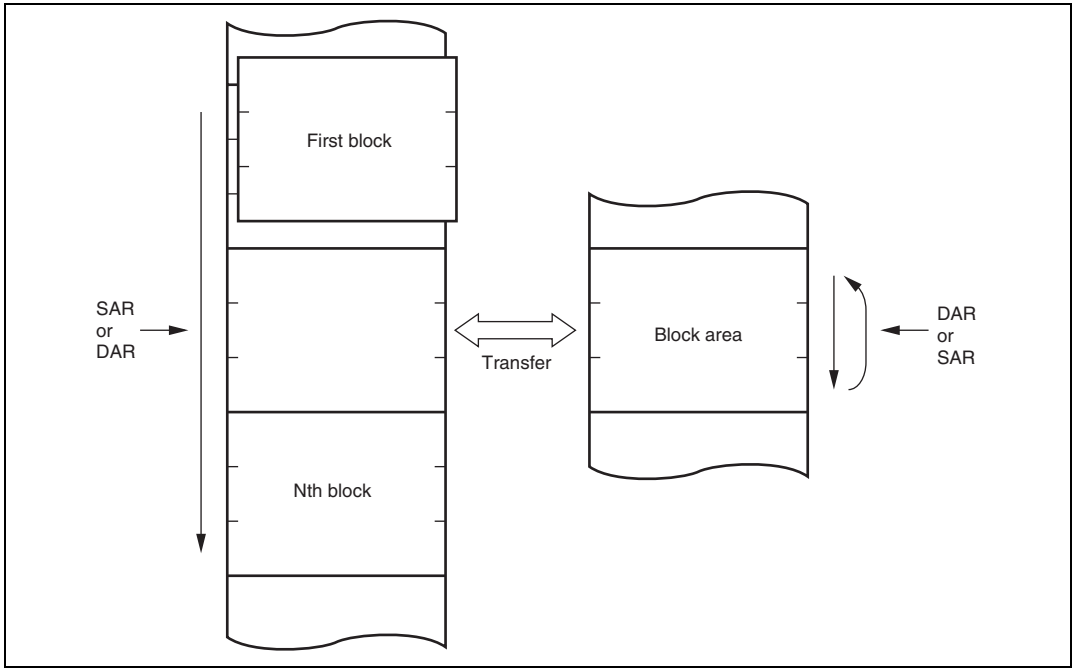


Figure 8.7 Memory Mapping in Block Transfer Mode

9.4 Port A

Port A is a 4-bit I/O port that also has other functions. Port A has the following registers. For details on register addresses and register states during each processing, refer to appendix A, On-Chip I/O Register.

- Port A data direction register (PADDR)
- Port A data register (PADR)
- Port A register (PORTA)
- Port A pull-up MOS control register (PAPCR)
- Port A open-drain control register (PAODR)

9.4.1 Port A Data Direction Register (PADDR)

PADDR is an 8-bit write-only register, the individual bits of which specify whether the pins of port A are used for input or output. PADDR cannot be read; if it is, an undefined value will be read.

Bit	Bit Name	Initial Value	R/W	Description
7	—	Undefined	—	Reserved
6	—	Undefined	—	
5	—	Undefined	—	
4	—	Undefined	—	
3	PA3DDR	0	W	When a pin is specified as a general purpose I/O port, setting this bit to 1 makes the corresponding port A pin an output pin. Clearing this bit to 0 makes the pin an input pin.
2	PA2DDR	0	W	
1	PA1DDR	0	W	
0	PA0DDR	0	W	

Input Capture Function: The TCNT value can be transferred to TGR on detection of the TIOC pin input edge.

Rising edge, falling edge, or both edges can be selected as the detected edge. For channels 0, 1, 3, and 4, it is also possible to specify another channel's counter input clock or compare match signal as the input capture source.

Note: When another channel's counter input clock is used as the input capture input for channels 0 and 3, ϕ/1 should not be selected as the counter input clock used for input capture input. Input capture will not be generated if ϕ/1 is selected.

1. Example of input capture operation setting procedure
   Figure 10.8 shows an example of the input capture operation setting procedure.

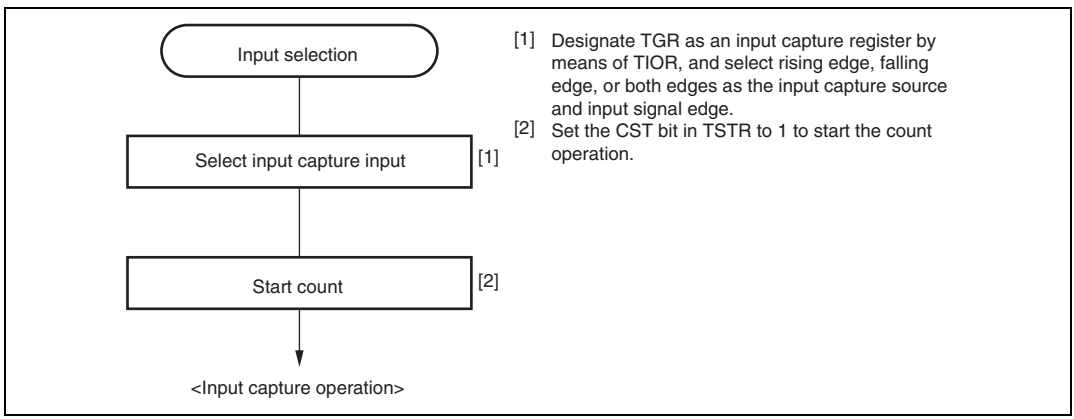


Figure 10.8 Example of Input Capture Operation Setting Procedure

Example of Synchronous Operation: Figure 10.11 shows an example of synchronous operation.

In this example, synchronous operation and PWM mode 1 have been designated for channels 0 to 2, TGRB_0 compare match has been set as the channel 0 counter clearing source, and synchronous clearing has been set for the channel 1 and 2 counter clearing source.

Three-phase PWM waveforms are output from pins TIOC0A, TIOC1A, and TIOC2A. At this time, synchronous presetting, and synchronous clearing by TGRB_0 compare match, are performed for channel 0 to 2 TCNT counters, and the data set in TGRB_0 is used as the PWM cycle.

For details of PWM modes, see section 10.4.5, PWM Modes.

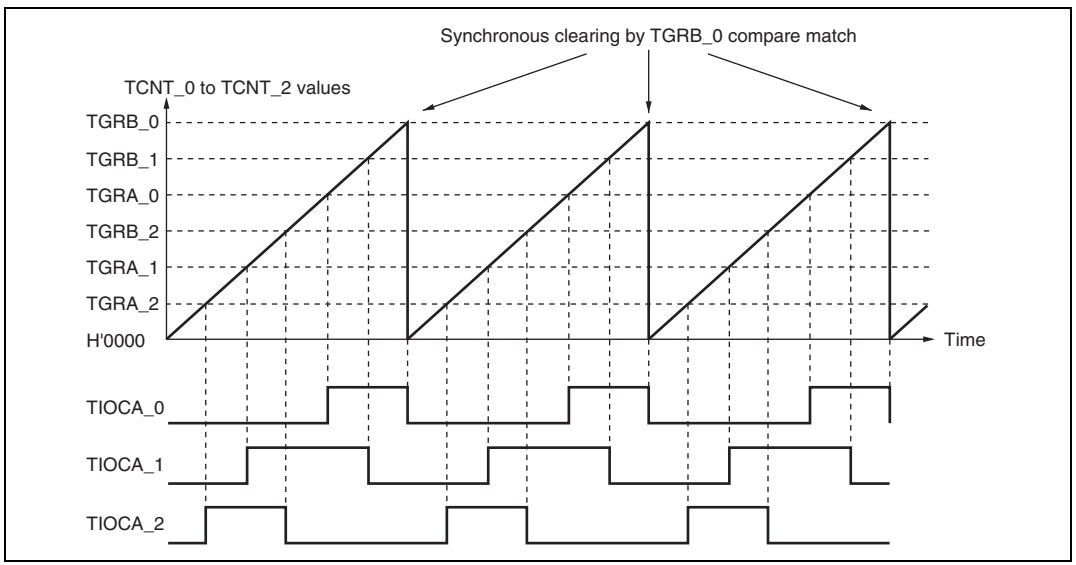


Figure 10.11 Example of Synchronous Operation

Input Capture/Compare Match Interrupt: An interrupt is requested if the TGIE bit in TIER is set to 1 when the TGF flag in TSR is set to 1 by the occurrence of a TGR input capture/compare match on a particular channel. The interrupt request is cleared by clearing the TGF flag to 0. The TPU has 16 input capture/compare match interrupts, four each for channels 0 and 3, and two each for channels 1, 2, 4, and 5.

Overflow Interrupt: An interrupt is requested if the TCIEV bit in TIER is set to 1 when the TCFV flag in TSR is set to 1 by the occurrence of TCNT overflow on a channel. The interrupt request is cleared by clearing the TCFV flag to 0. The TPU has six overflow interrupts, one for each channel.

Underflow Interrupt: An interrupt is requested if the TCIEU bit in TIER is set to 1 when the TCFU flag in TSR is set to 1 by the occurrence of TCNT underflow on a channel. The interrupt request is cleared by clearing the TCFU flag to 0. The TPU has four underflow interrupts, one each for channels 1, 2, 4, and 5.

10.6 DTC Activation

The DTC can be activated by the TGR input capture/compare match interrupt for a channel. For details, see section 8, Data Transfer Controller (DTC).

A total of 16 TPU input capture/compare match interrupts can be used as DTC activation sources, four each for channels 0 and 3, and two each for channels 1, 2, 4, and 5.

10.7 A/D Converter Activation

The A/D converter can be activated by the TGRA input capture/compare match for a channel.

If the TTGE bit in TIER is set to 1 when the TGFA flag in TSR is set to 1 by the occurrence of a TGRA input capture/compare match on a particular channel, a request to begin A/D conversion is sent to the A/D converter. If the TPU conversion start trigger has been selected on the A/D converter side at this time, A/D conversion is begun.

In the TPU, a total of six TGRA input capture/compare match interrupts can be used as A/D converter conversion start sources, one for each channel.

Buffer Operation Timing: Figure 11.13 shows the compare match buffer operation timing.

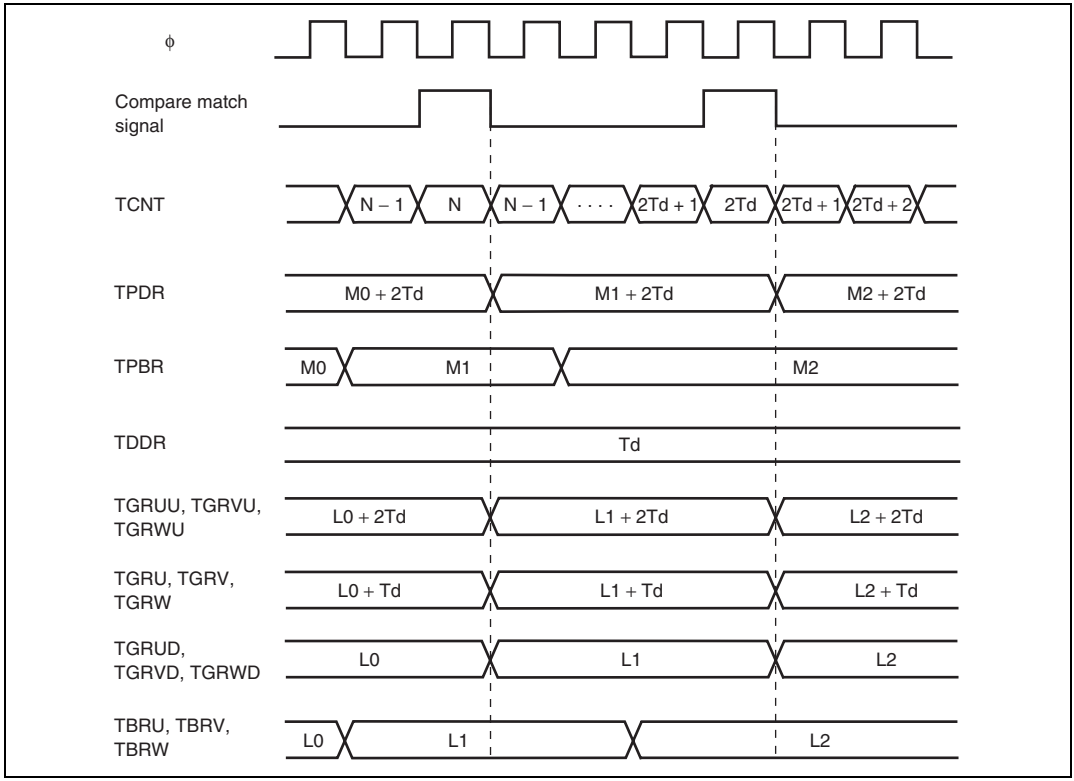


Figure 11.13 Buffer Operation Timing

Contention between Compare Register Write and Compare Match: If a compare match occurs in the T_3 state of a compare register (TGR or TPDR) write cycle, the compare register write is not performed, and data is transferred from the buffer register (TBRU, TBRV, TBRW, or TPBR) to the compare register by a buffer operation.

Figure 11.18 shows the timing in this case.

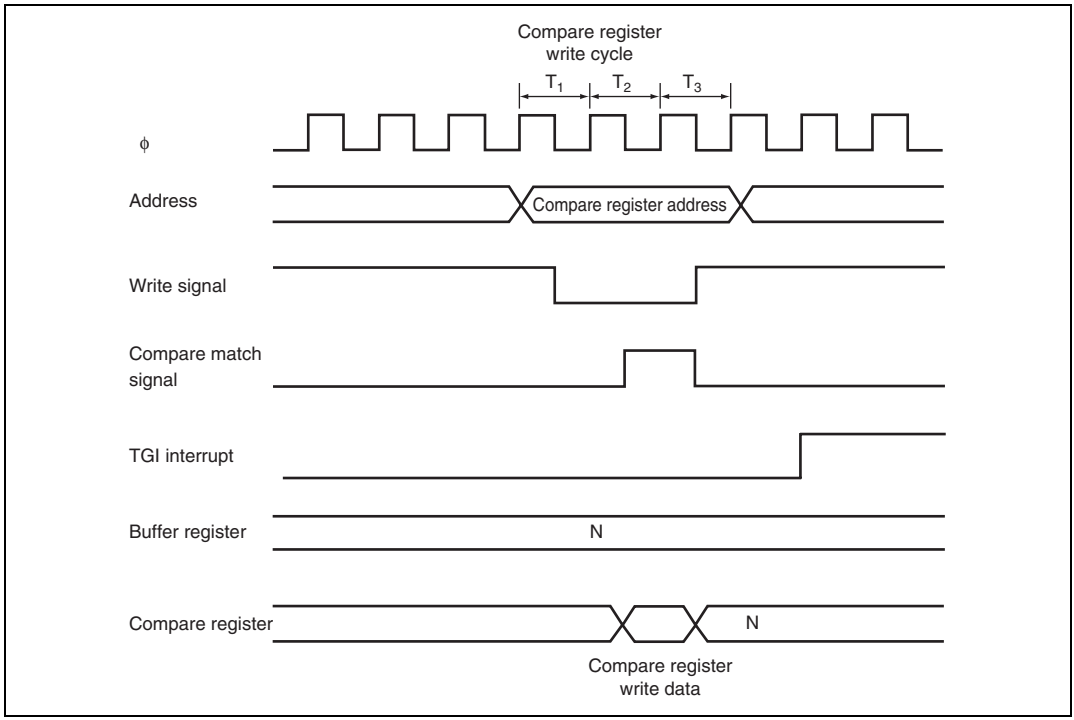


Figure 11.18 Contention between Compare Register Write and Compare Match

12.2 Input/Output Pins

Table 12.1 summarizes the I/O pins of the PPG.

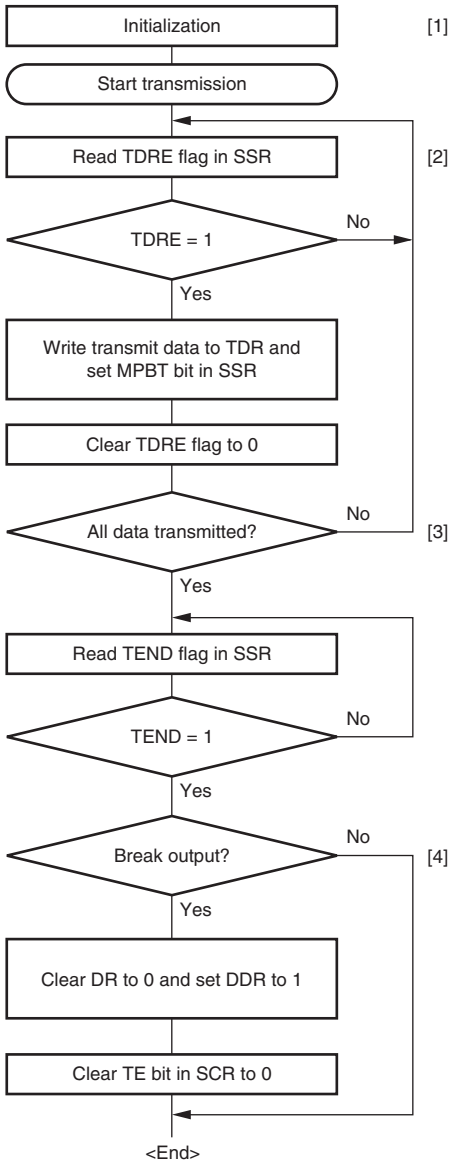
Table 12.1 PPG I/O Pins

Pin Name	I/O	Function
PO15	Output	Group 3 pulse output
PO14	Output	
PO13	Output	
PO12	Output	
PO11	Output	Group 2 pulse output
PO10	Output	
PO9	Output	
PO8	Output	

12.3 Register Descriptions

The PPG has the following registers. For details on register addresses and register states during each processing, refer to appendix A, On-Chip I/O Register.

- PPG output control register (PCR)
- PPG output mode register (PMR)
- Next data enable register H (NDERH)
- Next data enable register L (NDERL)
- Output data register H (PODRH)
- Output data register L (PODRL)
- Next data register H (NDRH)
- Next data register L (NDRL)



[1] SCI initialization:
The TxD pin is automatically designated as the transmit data output pin.
After the TE bit is set to 1, a frame of 1s is output, and transmission is enabled.

[2] SCI status check and transmit data write:
Read SSR and check that the TDRE flag is set to 1, then write transmit data to TDR. Set the MPBT bit in SSR to 0 or 1.
Finally, clear the TDRE flag to 0.

[3] Serial transmission continuation procedure:
To continue serial transmission, be sure to read 1 from the TDRE flag to confirm that writing is possible, then write data to TDR, and then clear the TDRE flag to 0. Checking and clearing of the TDRE flag is automatic when the DTC is activated by a transmit data empty interrupt (TXI) request, and data is written to TDR.

[4] Break output at the end of serial transmission:
To output a break in serial transmission, set the port DDR to 1, clear DR to 0, then clear the TE bit in SCR to 0.

Figure 14.11 Sample Multiprocessor Serial Transmission Flowchart

can be requested, and if the mailbox empty interrupt (IRR8) is enabled for the bits (MBIMR1 to MBIMR15) corresponding to the mailbox interrupt mask register (MBIMR) and interrupt mask register (IMR), interrupts may be sent to the CPU.

However, a transmit wait message cannot be canceled at the following times:

- During internal arbitration or CAN bus arbitration
- During data frame or remote frame transmission

Figure 15.10 shows a flowchart for transmit message cancellation.

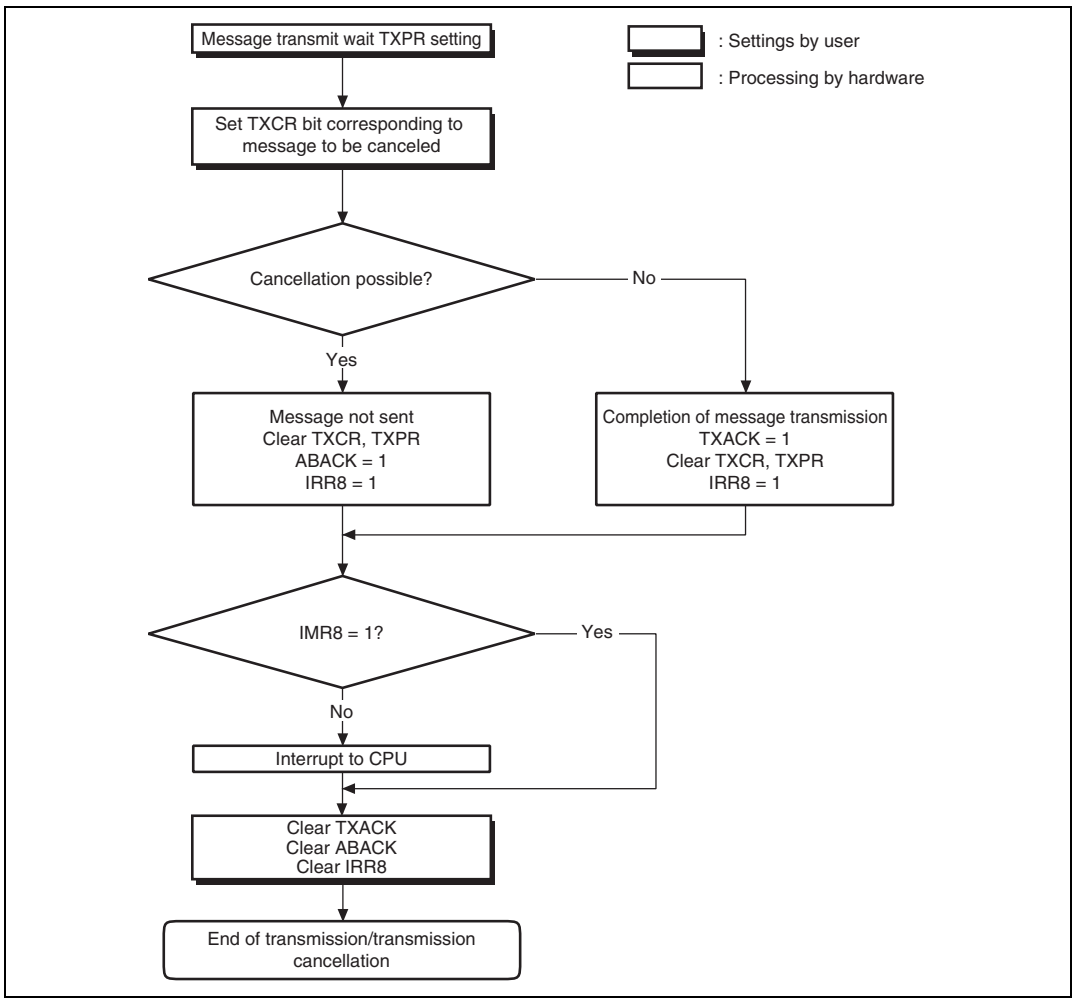


Figure 15.10 Transmit Message Cancellation Flowchart

15.5 Interrupts

Table 15.4 lists the HCAN interrupt sources. With the exception of the reset processing vector (IRR0), these sources can be masked. Masking is implemented using the mailbox interrupt mask register (MBIMR) and interrupt mask register (IMR). For details on the interrupt vector of each interrupt source, refer to section 5, Interrupt Controller.

Table 15.4 HCAN Interrupt Sources

Name	Description	Interrupt Flag	DTC Activation
ERS0/OVR0	Error passive interrupt (TEC ≥ 128 or REC ≥ 128)	IRR5	Not possible
	Bus off interrupt (TEC ≥ 256)	IRR6	
	Reset process interrupt by power-on reset	IRR0	
	Remote frame reception	IRR2	
	Error warning interrupt (TEC ≥ 96)	IRR3	
	Error warning interrupt (REC ≥ 96)	IRR4	
	Overload frame transmission interrupt	IRR7	
	Unread message overwrite	IRR9	
	Detection of CAN bus operation in HCAN sleep mode	IRR12	
RM0	Mailbox 0 message reception	IRR1	Possible
RM1	Mailboxes 1 to 15 message reception	IRR1	Not possible
SLE0	Message transmission/cancellation	IRR8	Not possible

16.6 A/D Conversion Precision Definitions

This LSI's A/D conversion precision definitions are given below.

- Resolution

  The number of A/D converter digital output codes
- Quantization error

  The deviation inherent in the A/D converter, given by 1/2 LSB (see figure 16.4).
- Offset error

  The deviation of the analog input voltage value from the ideal A/D conversion characteristic when the digital output changes from the minimum voltage value B'0000000000 (H'00) to B'0000000001 (H'01) (see figure 16.5).
- Full-scale error

  The deviation of the analog input voltage value from the ideal A/D conversion characteristic when the digital output changes from B'1111111110 (H'3E) to B'1111111111 (H'3F) (see figure 16.5).
- Nonlinearity error

  The error with respect to the ideal A/D conversion characteristic between zero voltage and full-scale voltage. Does not include offset error, full-scale error, or quantization error (see figure 16.5).
- Absolute precision

  The deviation between the digital value and the analog input value. Includes offset error, full-scale error, quantization error, and nonlinearity error.

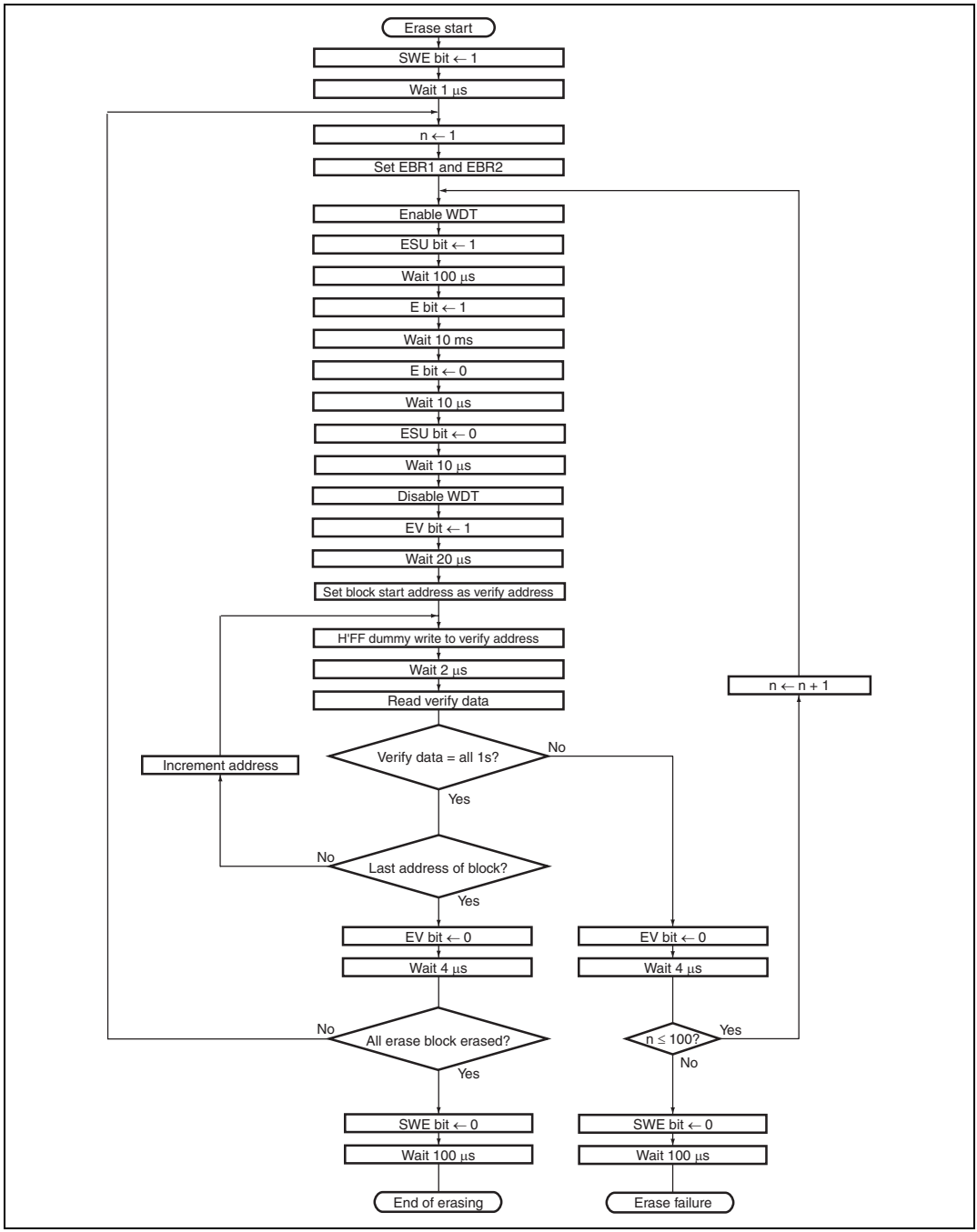


Figure 18.10 Erase/Erase-Verify Flowchart

When the $\overline{\text{RES}}$ pin is set low and medium-speed mode is cancelled, operation shifts to the reset state. The same applies in the case of a reset caused by overflow of the watchdog timer.

When the $\overline{\text{STBY}}$ pin is driven low, a transition is made to hardware standby mode.

Figure 20.2 shows the timing for transition to and clearance of medium-speed mode.

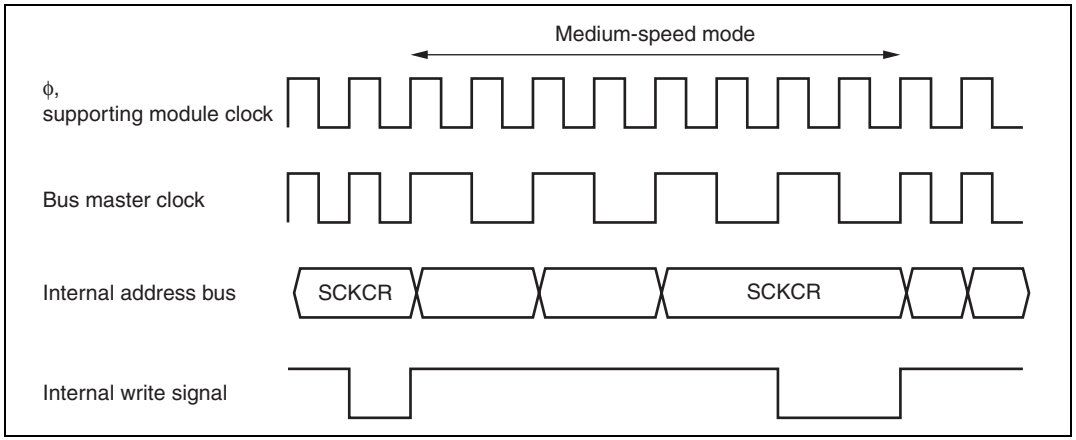


Figure 20.2 Medium-Speed Mode Transition and Clearance Timing